

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1059542	catalyst or (catalyst adj body)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/11 15:46
S2	37568	S1 and (microfab \$ or etch\$ or wet \$1etch or dry \$1etch or photolith\$)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/11 15:47
S3	3229	S2 and ((multiple or bonded or anneal \$) adj (stack or layer or wafer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/11 15:51
S4	2502	S3 and (pores or holes or channels)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/11 15:52
S5	1903	S4 and (silicon or (silicon adj alloy))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/11 16:04
S13	1060001	catalyst or (catalyst adj body)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:01
S14	37648	S13 and (microfab\$ or etch\$ or wet \$1etch or dry \$1etch or photolith\$)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:01

S15	3245	S14 and ((multiple or bonded or anneal \$) adj (stack or layer or wafer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:01
S16	2515	S15 and (pores or holes or channels)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:01
S17	1911	S16 and (silicon or (silicon adj alloy))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:01
S18	1241	S17 and support	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:01
S19	1128	catalytic adj reformer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:04
S20	0	S18 and S19	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:06
S21	29831	catalyst adj (support or substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:21
S22	1276	S21 and (microfab\$ or etch\$ or wet \$1etch or dry \$1etch or photolith\$)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:21

S23	1052	S22 and (pores or holes or channels or cavities or features)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:22
S25	123	S23 and ((multiple or bonded or anneal \$) adj (stack or layer or wafer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 14:28
S26	138	nanoporous adj silicon	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 16:42
S27	29831	catalyst adj (support or substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 17:57
S28	1276	S27 and (microfab\$ or etch\$ or wet \$1etch or dry \$1etch or photolith\$)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 17:57
S29	1052	S28 and (pores or holes or channels or cavities or features)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 17:57
S30	663	S29 and silicon	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 17:57
S31	497	S27 and ((multiple or bonded or anneal \$) adj (stack or layer or wafer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/12 17:58

S51	128163	fuel adj cell	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 18:39
S52	1130	catalytic adj reformer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 18:40
S53	198	S51 and S52	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/19 18:40
S54	128163	fuel adj cell	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/20 15:10
S55	11009	S54 and reformer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/20 15:45
S56	198	S54 and (catalytic adj reformer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/20 15:48

6/ 20/ 2008 6:23:24 PM

C:\Documents and Settings\mforrest\My Documents\EAST\Workspaces\ 10525359pa.  
wsp